

#### **RELIABILITY TESTS • STANDARD**

#### Reference JIS C 5101-1, JIS C 5101-4 and JIS 60068-2

No.	Test	Test Specification	Test Standard	Sample Quantity	Test Criteria
1	Shelf life	Upper category temperature Duration: 1000h	JIS C 5101-4 No. 4.17 JIS C 5101-1 No. 4.25	10 pcs	<ol> <li> ΔC/C<sub>R</sub>  ≤ 20% of initial value<sup>[1]</sup></li> <li>tanδ ≤ 2 times spec. limit<sup>[1]</sup></li> <li>I<sub>LEAK</sub> ≤ spec. limit</li> <li>ESR ≤ spec. limit</li> <li>No visible damage</li> <li>Marking legible</li> </ol>
2	Temperature cycling	<ul> <li>a. Lower category temperature: 30mins</li> <li>b. Temperature change: 3mins</li> <li>c. Upper category temperature: 30mins</li> <li>d. Temperature change: 3mins</li> <li>Step 1 to 4 as a cycle</li> <li>Cycle: 10 cycles</li> </ul>	JIS C 5101-4 No. 4.7 JIS C 5101-1 No. 4.16	10 pcs	<ol> <li> ΔC/C<sub>R</sub>  ≤ 5% of initial value</li> <li>tanδ ≤ spec. limit</li> <li>I<sub>LEAK</sub> ≤ spec. limit</li> <li>ESR ≤ spec. limit</li> <li>No visible damage</li> <li>Marking legible</li> </ol>
3	Unbiased humidity	Temperature: $60^{\circ}\text{C} \pm 2^{\circ}\text{C}$ Humidity: $90 \sim 95\%\text{RH}$ Duration: $1000\text{h}$	JIS C 5101-4 No. 4.12 JIS C 5101-1 No. 4.22	10 pcs	<ol> <li> ΔC/C<sub>R</sub>  ≤ 20% of initial value</li> <li>tanδ ≤ 1.5 times of spec. limit</li> <li>I<sub>LEAK</sub> ≤ spec. limit</li> <li>ESR ≤ spec. limit</li> <li>No visible damage</li> <li>Marking legible</li> </ol>
4	Endurance (load Life)	Upper category temperature $V_R$ applied Duration: specified or see detail specification	JIS C 5101-4 No. 4.13 JIS C 5101-1 No. 4.23	10 pcs	<ol> <li> ΔC/C<sub>R</sub>  ≤ 20% of initial value<sup>[1]</sup></li> <li>tanδ ≤ 1.5 times spec. limit<sup>[1]</sup></li> <li>I<sub>LEAK</sub> ≤ spec. limit</li> <li>ESR ≤ spec. limit</li> <li>No visible damage</li> <li>Marking legible</li> </ol>
5	Endurance (Load ripple current life)	Upper category temperature $I_R$ and $V_R$ applied $AC + DC \approx V_R$ Duration: specified or see detail specification	JIS C 5101-4 No. 4.13 JIS C 5101-1 No. 4.23	10 pcs	<ol> <li> ΔC/C<sub>R</sub>  ≤ 20% of initial value<sup>[1]</sup></li> <li>tanδ ≤ 1.5 times spec. limit<sup>[1]</sup></li> <li>I<sub>LEAK</sub> ≤ spec. limit</li> <li>ESR ≤ spec. limit</li> <li>No visible damage</li> <li>Marking legible</li> </ol>
6	Solvent resistance of marking	<ul> <li>a. Solvent to be used: IPA</li> <li>b. Solvent temperature: 23°C ± 5°C</li> <li>c. Conditioning: Method 1 (with rubbing)</li> <li>d. Rubbing material: Cotton wool</li> <li>e. Recovery time: Not applicable, unless otherwise stated in the detail specification</li> </ul>	JIS C 5101-1 No. 4.32 JIS C 60068- 2-45 3.1.2	5 pcs	See detail specification
7	Vibration	<ul> <li>a. Frequency: 10 ~ 55 Hz</li> <li>b. Swing (single peak) and acceleration: 0.75mm or 98m/s<sup>2</sup></li> <li>c. Test direction and duration: X, Y, Z each on for 2h</li> </ul>	JIS C 5101-4 No. 4.8 JIS C 5101-1 No. 4.17	10 pcs	Taking from the vibration table static placed in the horizontal to test the box and carton appearance, test the electrical characteristics.   1. $ \Delta C/C_R  \le 5\%$ of initial value   2. $\tan \delta \le \text{spec. limit}$ 3. $I_{\text{LEAK}} \le \text{spec. limit}$ 4. $\text{ESR} \le \text{spec. limit}$ 5. No visible damage   6. Marking legible



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#### Reference JIS C 5101-1, JIS C 5101-4 and JIS 60068-2

No.	Test	Test Specification	Test Standard	Sample Quantity	Test Criteria
8	Resistance to solder heat	Max. temperature: 260°C (0 ~ +3°C) Duration: 10s ± 1s	JIS C 5101-4 No. 4.5 JIS C 5101-1 No. 4.14	10 pcs	<ol> <li> ΔC/C<sub>R</sub>  ≤ 5% of initial value</li> <li>tanδ ≤ spec. limit</li> <li>I<sub>LEAK</sub> ≤ spec. limit</li> <li>ESR ≤ spec. limit</li> <li>No visible damage</li> <li>Marking legible</li> </ol>
9	Solderability	Max. temperature: 245°C ± 5°C Duration: 2s ± 0.5s	JIS C 5101-4 No. 4.6 JIS C 5101-1 No. 4.15	10 pcs	The surface soldering attachment is greater than 95% soldering should brightness and equality, non-soldering needle hole, drop weld or concentrate at some points are not allowed
10	Characteristics at high and low tempera- ture	The capacitors shall be measured at each temperature step Step 1: 20°C Capacitance, Tangent of loss angle, Impedance (at the same frequency as step 2) Step 2: Lower category temperature • Impedance Step 3: Upper category temperature • Leakage current See detail specification	JIS C 5101-4 No. 4.19 JIS C 5101-1 No. 4.29	10 pcs	See detail specification
11	Substrate bending	<ul> <li>The SMD capacitor shall be mounted on an epoxide woven glass printed board as described:</li> <li>a. The capacitance of the SMD capacitor shall be measured as specified in 4.7 and in the relevant sectional specification.</li> <li>b. The capacitor shall be subjected to JIS C 60068-2-21, test Ue, using the conditions as prescribed in the relevant specification for the deflection D and the number of bends.</li> <li>c. The capacitance of the SMD capacitor shall be measured as specified in (a) with the board in the bent position</li> </ul>	JIS C 5101-1 No. 4.35 JIS C 60068.2.21	5 pcs	The change of capacitance shall not exceed the limits prescribed by the relevant specification
12	Terminal strength	Test method: Following model picture means: Put the samples solder on the glass epoxy resin board, profile added force is 17.7N (1.8kg), time within 60s ± 1s See detail specification	JIS C 5101-1 No. 4.13 JIS C 5104-1 No. 4.4	10 pcs	See detail specification



#### **RELIABILITY TESTS • STANDARD**



#### Reference JIS C 5101-1, JIS C 5101-4 and JIS 60068-2

No.	Test	Test Specification	Test Standard	Sample Quantity	Test Criteria
13	Surge voltage	<ul> <li>a. Test temp: 15°C ~ 35°C.</li> <li>b. Add surge voltage to the connections: <ul> <li>1.25·V<sub>R</sub> when V<sub>R</sub>≤100V</li> <li>1.15·V<sub>R</sub> when V<sub>R</sub>&gt;100V</li> </ul> </li> <li>c. 6 min as a cycle (charge time 30s, discharge time 330s)</li> <li>d. Cycles: 1000 cycles</li> </ul>	JIS C 5101-4 No. 4.14 JIS C 5101-1 No. 4.26	10 pcs	<ol> <li> ΔC/C<sub>R</sub>  ≤ 10% of initial value</li> <li>tanδ ≤ spec. limit</li> <li>I<sub>LEAK</sub> ≤ spec. limit</li> <li>ESR ≤ spec. limit</li> <li>No visible damage</li> <li>Marking legible</li> </ol>
14	Storage at low temperature	Duration: 16h or 4h after thermal stability has been reached Temperature: -40°C	JIS C 5101-4 No. 4.18 JIS C 5101-1 No. 4.25	10 pcs	<ol> <li> ΔC/C<sub>R</sub>  ≤ 10% of initial value</li> <li>tanδ ≤ spec. limit</li> <li>I<sub>LEAK</sub> ≤ spec. limit</li> <li>ESR ≤ spec. limit</li> <li>No visible damage</li> <li>Marking legible</li> </ol>

#### Note:

[1]  $\Delta C/C_R$  & tan $\delta$  criterion, please refer to CapXon datasheet.



# **RELIABILITY TESTS • AUTOMOTIVE**





## Reference MIL-STD-202, JESD22, J-STD-002 and AEC-Q200

No.	Test	Test Specification	Test Standard	Sample Quantity	Test Criteria
1	High temperature exposure (Storage at upper category temperature	Test temp: Upper category temperature No voltage applied Duration: 1000h Pre-treatment for measurements shall be conducted after application of DC working voltage for 30 minutes Measurement at 24h after test conclusion	MIL-STD-202 Method 108	77 pcs	<ol> <li> ΔC/C<sub>R</sub>  ≤ 20% of initial value<sup>[1]</sup></li> <li>tanδ ≤ 2 times spec. limit<sup>[1]</sup></li> <li>I<sub>LEAK</sub> ≤ spec. limit</li> <li>ESR ≤ spec. limit</li> <li>No visible damage</li> </ol>
2	Temperature cycling	Stage Temperature Time  1 Lower category temperature Within 30min 2 Temperature change Within 1min 3 Upper category temperature Within 30min 4 Temperature change Within 1min  Stage 1 to 4 is one cycle Test time: 1000 cycles Measurement at 24h after test conclusion	JESD22 Method JA- 104	77 pcs	<ol> <li> ΔC/C<sub>R</sub>  ≤ 10% of initial value</li> <li>tanδ ≤ spec. limit</li> <li>I<sub>LEAK</sub> ≤ spec. limit</li> <li>ESR ≤ spec. limit</li> <li>No visible damage</li> <li>Marking legible</li> </ol>
3	Biased Humidity	Temperature: $85^{\circ}\text{C}$ Humidity: $85^{\circ}\text{RH}$ Applied voltage: $V_R$ Duration: $1000\text{h}$ Measurement at $24\text{h}$ after test conclusion	MIL-STD-202 Method 103	77 pcs	<ol> <li> ΔC/C<sub>R</sub>  ≤ 20% of initial value</li> <li>tanδ ≤ 1.2 times spec. limit</li> <li>I<sub>LEAK</sub> ≤ spec. limit</li> <li>ESR ≤ spec. limit</li> <li>No visible damage</li> <li>Marking legible</li> </ol>
4	Operational life	Test temp: Upper category temperature V <sub>R</sub> applied (&I <sub>R</sub> applied if specified) Duration: specified or see detail specification Measurement at 24h after test conclusion	MIL-STD-202 Method 108	77 pcs	<ol> <li> ΔC/C<sub>R</sub>  ≤ 20% of initial value<sup>[1]</sup></li> <li>tanδ ≤ 2 times spec. limit<sup>[1]</sup></li> <li>I<sub>LEAK</sub> ≤ spec. limit</li> <li>ESR ≤ spec. limit</li> <li>No visible damage</li> </ol>
5	Resistance to solvents	<ul> <li>a. Solvent to be used: IPA</li> <li>b. Soak time: Using the brush according to mark place to brush with 10 times after 180s, repeat above step again with 2 times (namely is total 3 times)</li> <li>c. After test place in air nature drying</li> <li>d. Test temperature: 25°C ± 5°C</li> </ul>	MIL-STD-202 Method 215	5 pcs	<ol> <li>No visible damage</li> <li>Marking legible</li> </ol>
6	Mechanical shock	<ul> <li>a. Pulse shape: Half-sine waveform</li> <li>b. Max. acceleration: 980m/s² (100g·s)</li> <li>c. Pulse duration time: 6ms</li> <li>d. Direction: X, Y, Z on 6 faces</li> <li>e. Shock time: 3 times in one face, 18 times in total.</li> </ul>	MIL-STD-202 Method 213	30 pcs	<ol> <li> ΔC/C<sub>R</sub>  ≤ 5% of initial value</li> <li>tanδ ≤ spec. limit</li> <li>I<sub>LEAK</sub> ≤ spec. limit</li> <li>ESR ≤ spec. limit</li> <li>No visible damage</li> </ol>



# **RELIABILITY TESTS • AUTOMOTIVE**





## Reference MIL-STD-202, JESD22, J-STD-002and AEC-Q200

No.	Test	Test Specification	Test Standard	Sample Quantity	Test Criteria
7	Vibration	<ul> <li>a. 10Hz ~ 2kHz ~ 10Hz (20min)</li> <li>b. Amplitude (Double peaks): 1.5mm @10 ~ 55Hz</li> <li>c. Acceleration: 49m/s² (5g·s) @55 ~ 2kHz</li> <li>d. X direction 4h     Y direction 4h     Z direction 4h     Total: 12h</li> </ul>	MIL-STD- 202 Meth- od 204	30 pcs	<ol> <li> ΔC/C<sub>R</sub>  ≤ 5% of initial value</li> <li>tanδ ≤ spec. limit</li> <li>I<sub>LEAK</sub> ≤ spec. limit</li> <li>ESR ≤ spec. limit</li> <li>No visible damage</li> </ol>
8	Resistance to solder heat	a. Kind of solder: H60A or equal b. Below diagram shows the products which in soldering stove of the 3 times reflow soldering c. When finish the first time and the samples temperature col off and become stable then will proceed the 2 <sup>nd</sup> time d. When finish the 2 <sup>nd</sup> time and the samples temperature col off and become stable then will proceed the 3 <sup>rd</sup> time  Tolder	MIL-STD- 202 Meth- od 210	30 pcs	<ol> <li> ΔC/C<sub>R</sub>  ≤ 15% of initial value</li> <li>tanδ ≤ spec. limit</li> <li>I<sub>LEAK</sub> ≤ spec. limit</li> <li>No visible damage</li> <li>* Products expanding</li> <li>≤ Ø 6.3mm below 0.2mm</li> <li>≥ Ø 8mm below 0.3mm</li> </ol>
9	Solderability	<ul> <li>SMD Reflow solder method</li> <li>a. Kind of solder:     Sn96.5%; Ag3%; Cu0.5%</li> <li>b. Pre-handle: 155°C, 4Hours+15min</li> <li>c. Solder stove temp.: 245°C ± 5°C</li> <li>d. Solder solvent: Resin alcohol solution (25 wts%) or resin IPA solution</li> <li>e. Immerse time: within 5 +0/-0.5 secs</li> <li>f. Immerse speed: 25±2.5mm/s</li> </ul>	J-STD-002	15 pcs	Up to immerse position, above 95% area of surroundings surface shall be cover by the new soldering



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## Reference MIL-STD-202, JESD22, J-STD-002and AEC-Q200

No.	Test	Co. c	Test	Test Standard	Sample		Test Criteria			
		·	cification environment to de- oducts	User spec.	Quantity 30 pcs			Products with lower category temperature -40°C		
		Stage	Temp. (°C)			stage 2 stage 3	tage ou	Comparison of temp section	Magnification	
		1 (initial value)	20±2					Z-25°C / Z+20°C	According to spec.	
		2	-25±3					Z-40°C / Z+20°C	According to spec.	
10	Electrical characteri-	3	-40±3					Products with lower category temperature -55°C		
10	zation	4	20±2					Comparison of temp section	Magnification	
		5	Upper category temperature±2					Z-25°C / Z+20°C	According to spec.	
		6	20±2					Z-55°C / Z+20°C	According to spec.	
			ncy: 120Hz of time: Reached time ce (temperature sta-			stage 5	<ol> <li> ΔC/C<sub>R</sub>  ≤ 30% of initial value</li> <li>tanδ ≤ spec. limit</li> <li>I<sub>LEAK</sub> ≤ 5 times spec. limit</li> </ol>			
11	Board flex (SMD)	PCB board, s (length) x 40 b. Curing test of follows:  Support  Sold  Radius 340  PCB under test		AEC-Q200 -005	30 pcs	<ol> <li> ΔC/C<sub>R</sub>  ≤ 5% of initial value</li> <li>tanδ ≤ spec. limit</li> <li>I<sub>LEAK</sub> ≤ spec. limit</li> <li>ESR ≤ spec. limit</li> <li>No visible damage</li> </ol>				



# **RELIABILITY TESTS - AUTOMOTIVE**





## Reference MIL-STD-202, JESD22, J-STD-002and AEC-Q200

No.	Test	Test Specification	Test Standard	Sample Quantity	Test Criteria
12	Terminal strength (SMD)	Test method: Following model picture means: Put the samples solder on the glass epoxy resin board, profile added force is 17.7N (1.8kg), time within 60s ± 1s  F  Glass epoxy resin board  Pad size: See dedicated packaging information	AEC-Q200 -006	30 pcs	<ol> <li> ΔC/C<sub>R</sub>  ≤ 5% of initial value</li> <li>tanδ ≤ spec. limit</li> <li>I<sub>LEAK</sub> ≤ spec. limit</li> <li>No unusual or loose situation on terminals</li> </ol>
13	Surge voltage	<ul> <li>a. Test temp: 15°C ~ 35°C.</li> <li>b. Add surge voltage to the connections: <ul> <li>1.25·V<sub>R</sub> when V<sub>R</sub> ≤ 100V</li> <li>1.15·V<sub>R</sub> when V<sub>R</sub> &gt;100V</li> </ul> </li> <li>c. 6 min as a cycle (charge time 30s, discharge time 330s)</li> <li>d. Cycles: 1000 cycles</li> </ul>	JIS C 5101-1 No. 4.26	30 pcs	<ol> <li> ΔC/C<sub>R</sub>  ≤ 15% of initial value</li> <li>tanδ ≤ spec. limit</li> <li>I<sub>LEAK</sub> ≤ spec. limit</li> <li>ESR ≤ spec. limit</li> <li>No visible damage</li> <li>Marking legible</li> </ol>

[1]  $\Delta C/C_R$  & tan $\delta$  criterion, please refer to CapXon datasheet.